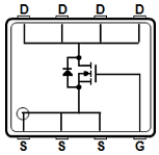
N Channel MOSFET
30V 105A DFN5×6-8L

MFT3N105D56

MERITEK

FEATURE

- RDS(ON)<2.8mΩ at VGS=10V
- RDS(ON)<4.8mΩ at VGS=4.5V
- Super High Dense Cell Design For Low RDS(ON).
- Fast Switching Speed
- Application: DC/DC Converter, Motor Control



RoHS

MECHANICAL DATA

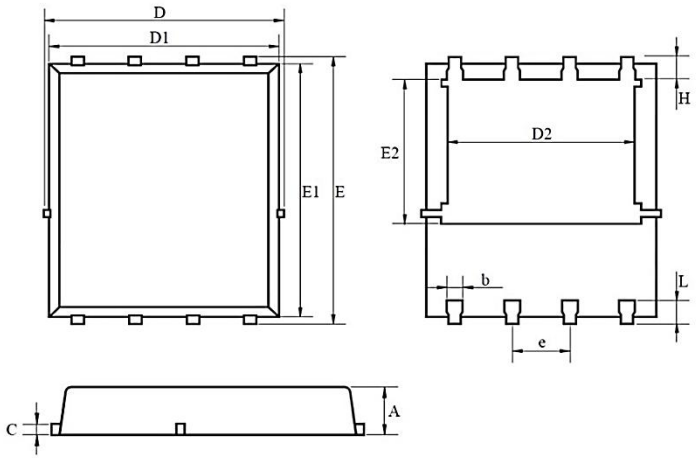
- Case: DFN5×6-8L, Molded Plastic
- Terminals: Solderable per MIL-STD-750, Method 2026

MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	±20	V
Drain Current – Continuous	T_C=25°C	I_D	105	A
	T_C=100°C		70	
Drain Current – Pulsed		I_{DM}	420	A
Power Dissipation	T_C=25°C	P_D	60	W
Single Pulse Avalanche Energy		E_{AS}	441	mJ
Thermal Resistance Junction to Case		$R_{\theta JC}$	2.1	°C/W
Operating Junction and Storage Temperature Range		T_J, T_{STG}	55 to +150	°C

DIMENSIONS

Item	Min. (mm)	Max. (mm)
A	0.900	1.000
b	0.350	0.450
c	0.254 BSC	
D	4.944	5.096
D1	4.824	4.976
D2	3.910	4.110
E	5.974	6.126
E1	5.674	5.826
E2	3.375	3.575
e	1.270 BSC	
L	0.559	0.711
H	0.574	0.726

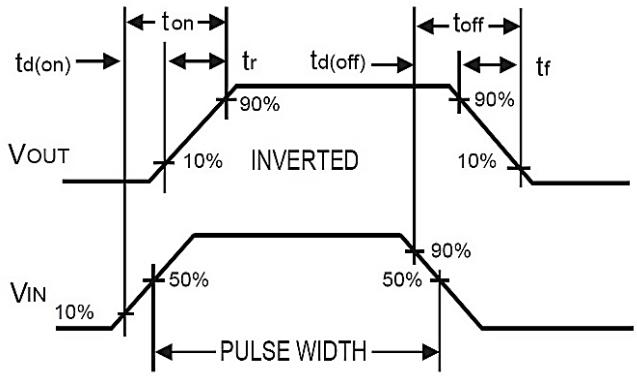


ELECTRICAL CHARACTERISTICS

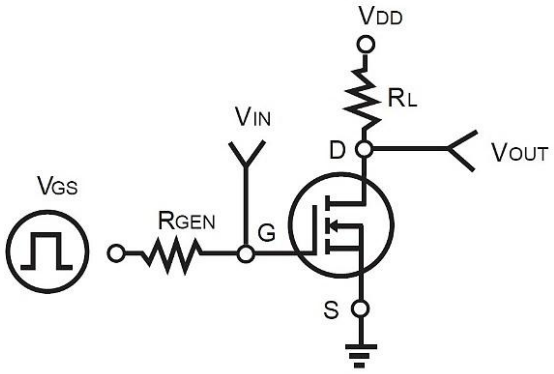
Off Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250μA	BV_{DSS}	30	--	--	V
Drain-Source Leakage Current	V_{DS}=24V, V_{GS}=0V	I_{DSS}	--	--	1	μA
Gate-Source Leakage Current	V_{GS}=±20V, V_{DS}=0V	I_{GSS}	--	--	±100	nA
On Characteristics	**Conditions**	**Symbol**	**Min**	**Typ.**	**Max**	**Unit**
Static Drain-Source On-Resistance	V_{GS}=10V, I_D=20A	$R_{DS(ON)}$	--	2.2	2.8	mΩ
	V_{GS}=4.5V, I_D=20A		--	3.6	4.8	
Gate Threshold Voltage	V_{GS}=V_{DS} , I_D=250μA	$V_{GS(th)}$	1.0	1.7	2.5	V
Dynamic Characteristics	**Conditions**	**Symbol**	**Min**	**Typ.**	**Max**	**Unit**
Total Gate Charge	V_{DS}=15V, V_{GS}=10V, I_D=30A	Q_g	--	75	--	nC
Gate-Source Charge		Q_{gs}	--	12	--	
Gate-Drain Charge		Q_{gd}	--	18.3	--	
Turn-On Delay Time	V_{DS}=15V, V_{GS}=4.5V, R_G=1.8Ω, I_D=60A	$T_{d(on)}$	--	11	--	nS
Rise Time		T_r	--	20	--	
Turn-Off Delay Time		$T_{d(off)}$	--	60	--	
Fall Time		T_f	--	29	--	
Input Capacitance	V_{DS}=25V, V_{GS}=0V, F=1MHz	C_{iss}	--	3550	--	pF
Output Capacitance		C_{oss}	--	456	--	
Reverse Transfer Capacitance		C_{rss}	--	388	--	
Drain-Source Body Diode	**Conditions**	**Symbol**	**Min**	**Typ.**	**Max**	**Unit**
Diode Forward Current	--	I_S	--	--	105	A
Diode Forward Voltage	V_{GS}=0V , I_S=1A, T_J=25°C	V_{SD}	--	--	1.2	V
Reverse Recovery Time	I_F=20A, di/dt=100A/μs, T_J=25°C	T_{rr}	--	19	--	ns
Reverse Recovery Charge		Q_{rr}	--	7	--	nC

Note:
1. T_A=25°C, unless otherwise noted
2. The E_{AS} test condition is V_{DD} =20V, V_{GS} =10V, L =0.5mH, Rg =25Ω.

Switching Time Waveform

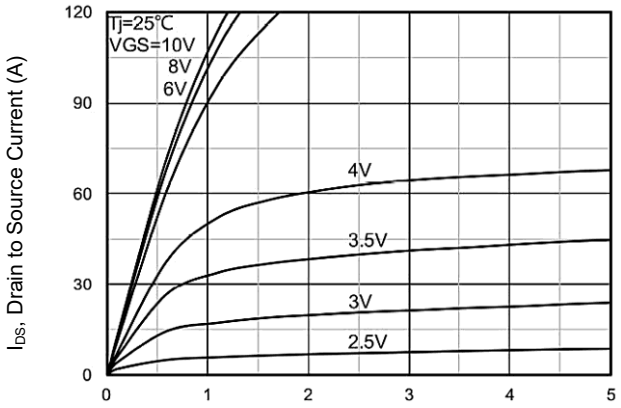


Switching Test Circuit

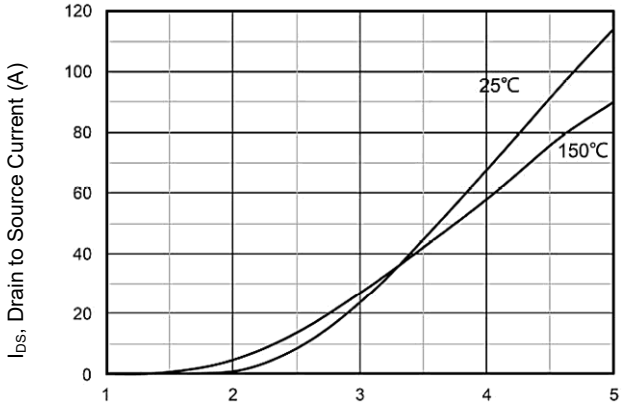


CHARACTERISTIC CURVES

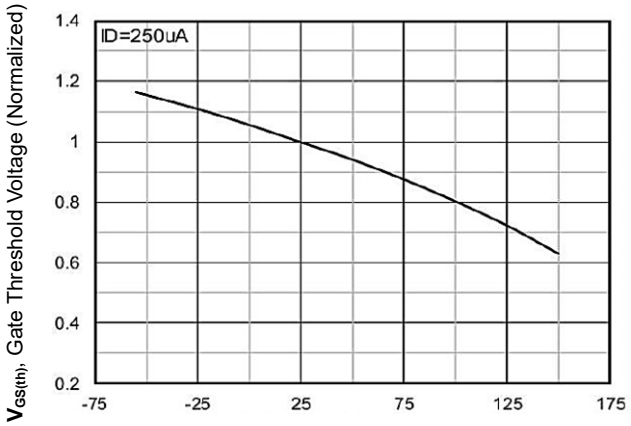
On-Region Characteristics



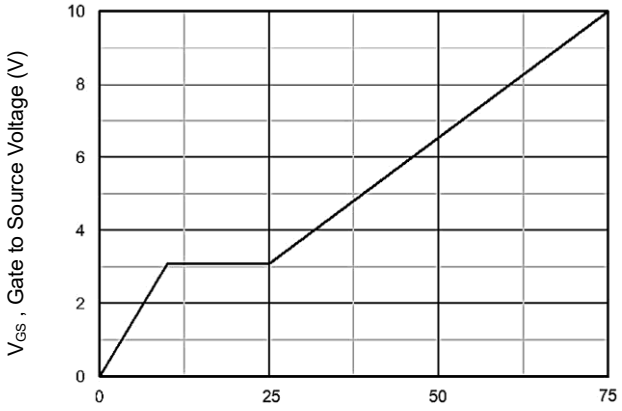
Transfer Characteristics



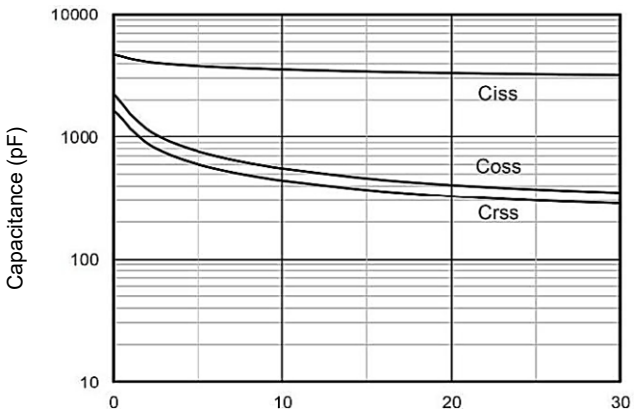
Gate Threshold Voltage **vs Temperature**



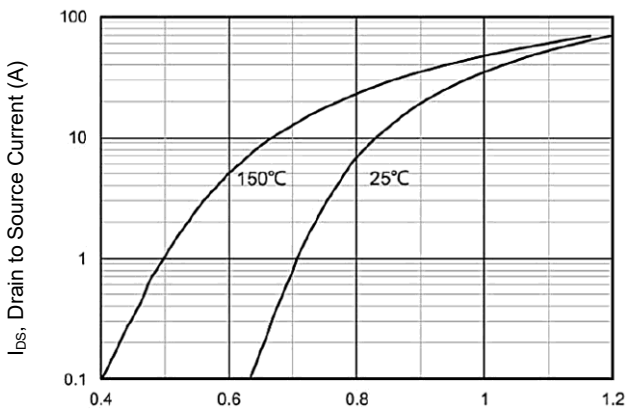
Gate Charge Waveform



Capacitance vs. Drain-Source Voltage

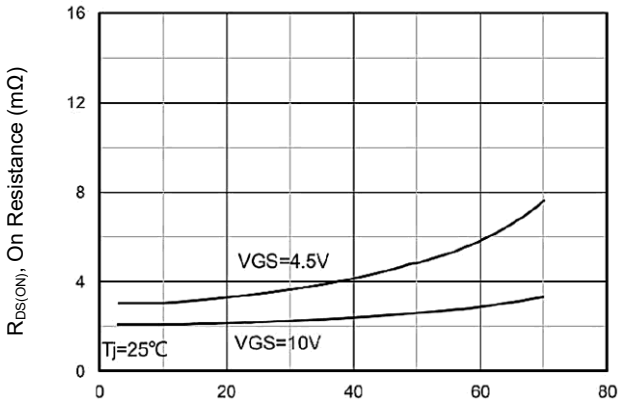


Body Diode Forward Voltage

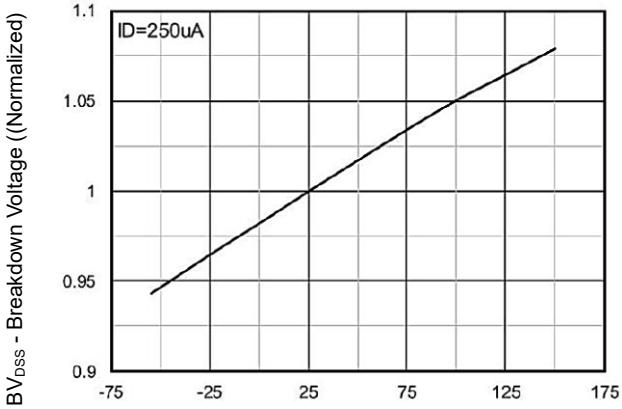


CHARACTERISTIC CURVES

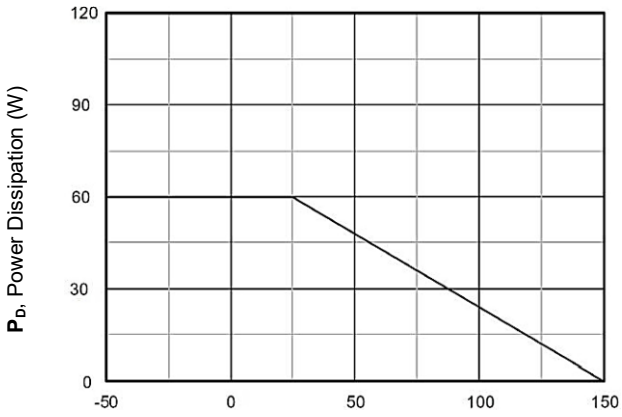
On-Resistance Variation with Drain Current



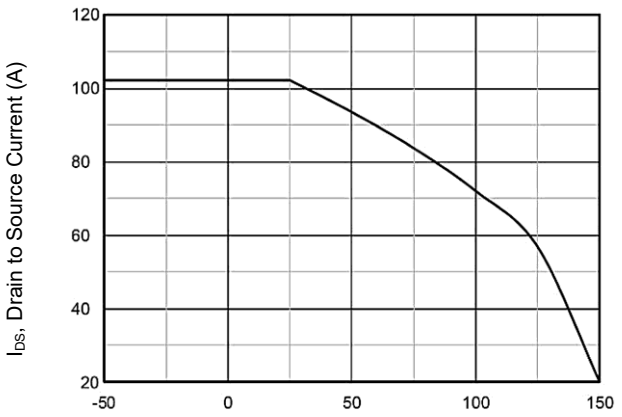
Breakdown Voltage vs Temperature



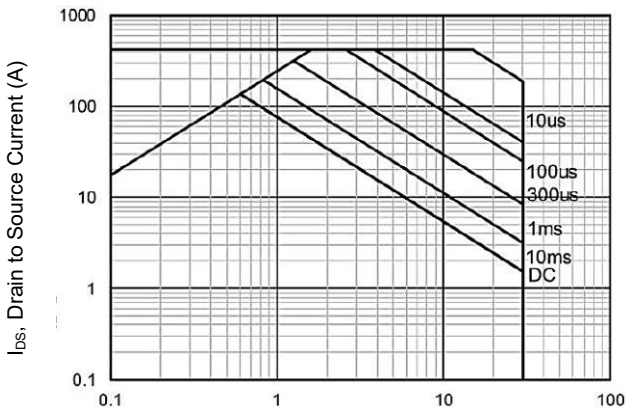
Power Dissipation



Current Dissipation



Maximum Safe Operating Area



Transient Thermal Impedance